

1. Product Information

1.1 Features

- Advanced trench cell design
- Low Thermal Resistance

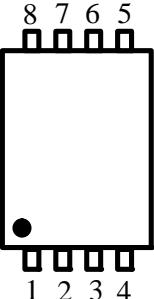
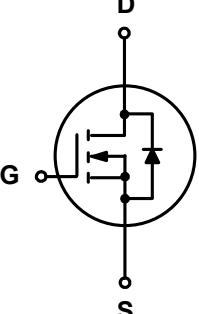
1.2 Applications

- Motor drivers
- DC - DC Converter

1.3 Quick reference

- $BV \geq 30\text{ V}$
- $P_{tot} \leq 227\text{ W}$
- $I_D \leq 502\text{ A}$
- $R_{DS(ON)} \leq 0.6\text{ m}\Omega @ V_{GS} = 10\text{ V}$
- $R_{DS(ON)} \leq 0.95\text{ m}\Omega @ V_{GS} = 4.5\text{ V}$

2. Pin Description

Pin	Description	Simplified Outline	Symbol
1,2,3	Source		
4	Gate		
5,6,7,8	Drain	 Top View	 PDFN-8 (5x6)

3. Maximum Ratings

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	Drain-Source Voltage	$T_C = 25^\circ C$	-	30	V
V_{GS}	Gate-Source Voltage	$T_C = 25^\circ C$	-	± 20	V
I_D^*	Drain Current	$T_C = 25^\circ C, V_{GS} = 10 V$	-	502	A
		$T_C = 100^\circ C, V_{GS} = 10 V$	-	316	A
I_{DM}^{***}	Pulsed Source Current	$T_C = 25^\circ C, V_{GS} = 10 V$	-	1000	A
P_{tot}^*	Total Power Dissipation	$T_C = 25^\circ C$	-	227	W
T_{stg}	Storage Temperature		-55	150	$^\circ C$
T_J	Junction Temperature		-	150	$^\circ C$
I_S	Diode Forward Current	$T_C = 25^\circ C$	-	502	A
E_{AS}^*	Single Pulsed Avalanche Energy	$V_{DD} = 30 V, L = 1.0 mH$	-	420	mJ
$R_{\theta JA}^*$	Thermal Resistance- Junction to Ambient		-	60	$^\circ C / W$
$R_{\theta JC}^*$	Thermal Resistance- Junction to Case		-	0.55	

Notes :

* Surface Mounted on 1 in² pad area, t ≤ 10 sec

** Pulse width ≤ 300 μs, duty cycle ≤ 2 %

*** Limited by bonding wire

4. Ordering Information

Device	Package	Packing
AICN007N03	PDFN-8 (5x6)	Tape & Reel

5. Electrical Characteristics ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	30	-	-	V
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$, $I_{\text{DS}} = 250 \mu\text{A}$	1	-	2	V
I_{DSS}	Zero Gate Voltage Source Current	$V_{\text{DS}} = 24 \text{ V}$, $V_{\text{GS}} = 0 \text{ V}$	-	-	1	μA
I_{GSS}	Gate Leakage Current	$V_{\text{GS}} = \pm 20 \text{ V}$, $V_{\text{DS}} = 0 \text{ V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\text{a}}$	Drain-Source On-State Resistance	$V_{\text{GS}} = 10 \text{ V}$, $I_D = 50 \text{ A}$	-	0.5	0.6	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5 \text{ V}$, $I_D = 30 \text{ A}$	-	0.73	0.95	
Diode Characteristics						
V_{SD}^{a}	Diode Forward Voltage	$I_{\text{SD}} = 50 \text{ A}$, $V_{\text{GS}} = 0 \text{ V}$	-	-	1.3	V
t_{rr}	Reverse Recovery Time	$I_{\text{SD}} = 30 \text{ A}$, $dI_{\text{SD}}/dt = 100 \text{ A}/\mu\text{s}$	-	83	-	nS
Q_{rr}	Reverse Recovery Charge		-	113	-	nC
Dynamic Characteristics^b						
C_{iss}	Input Capacitance	$V_{\text{GS}} = 0 \text{ V}$, $V_{\text{DS}} = 15 \text{ V}$ Frequency = 1 MHz	-	8010	-	pF
C_{oss}	Output Capacitance		-	3467	-	
C_{rss}	Reverse Transfer Capacitance		-	237	-	
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DS}} = 15 \text{ V}$, $V_{\text{GEN}} = 10 \text{ V}$, $R_G = 4.5 \Omega$, $R_L = 0.3 \Omega$, $I_{\text{DS}} = 50 \text{ A}$	-	12.6	-	nS
t_r	Turn-on Rise Time		-	93	-	
$t_{\text{d(off)}}$	Turn-off Delay Time		-	159	-	
t_f	Turn-off Fall Time		-	119	-	
Gate Charge Characteristics^b						
Q_g	Total Gate Charge	$V_{\text{DS}} = 15 \text{ V}$, $V_{\text{GS}} = 10 \text{ V}$, $I_{\text{DS}} = 50 \text{ A}$	-	142	-	nC
Q_{gs}	Gate-Source Charge		-	26	-	
Q_{gd}	Gate-Drain Charge		-	27	-	

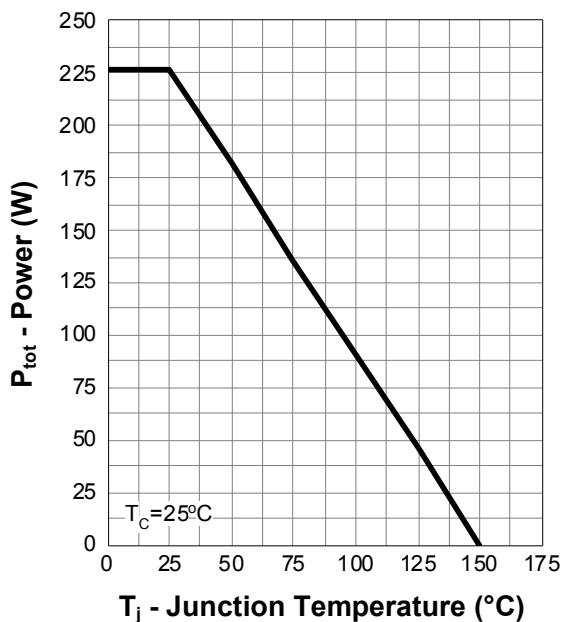
Notes :

a : Pulse test ; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2 \%$

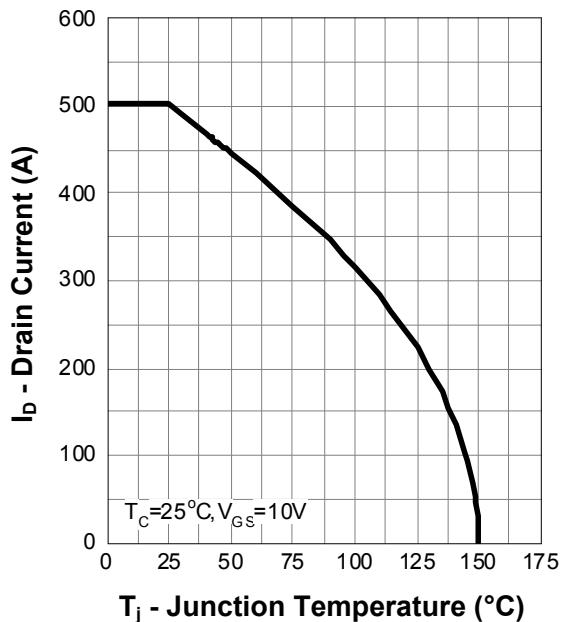
b : Guaranteed by design, not subject to production testing

6. Typical Characteristics (Cont.)

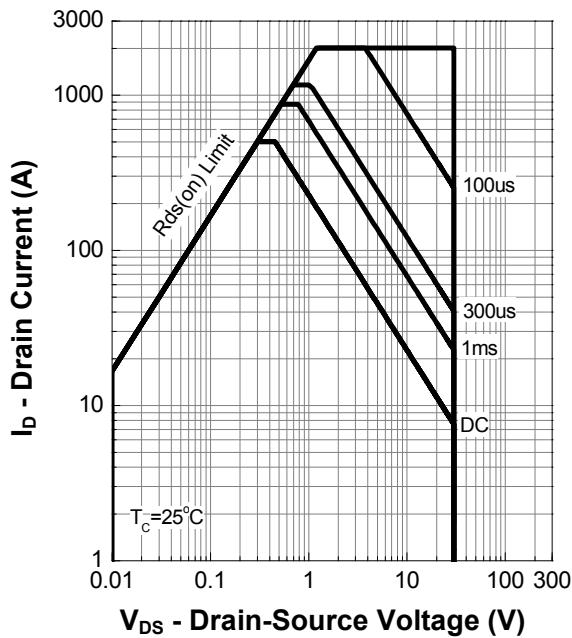
Power Capability



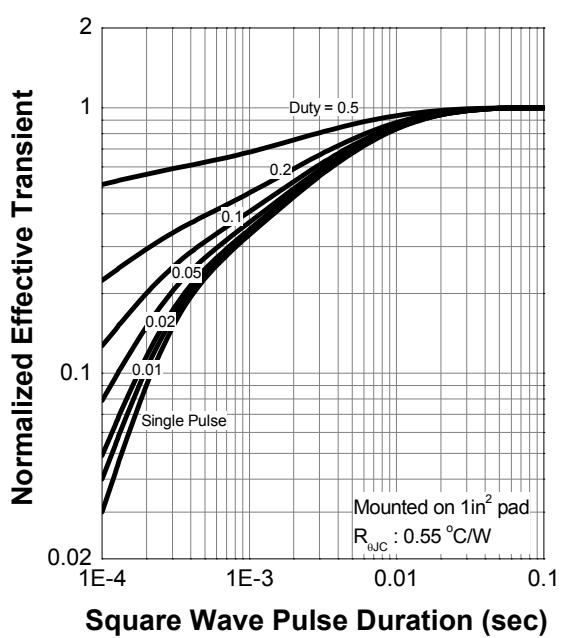
Current Capability



Safe Operation Area

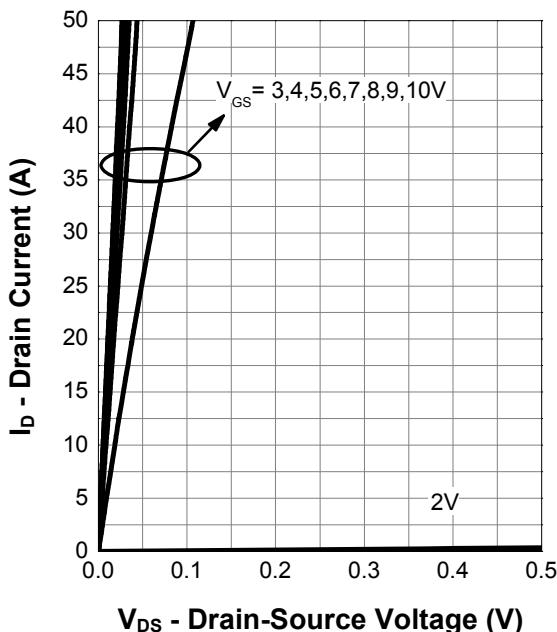


Transient Thermal Impedance

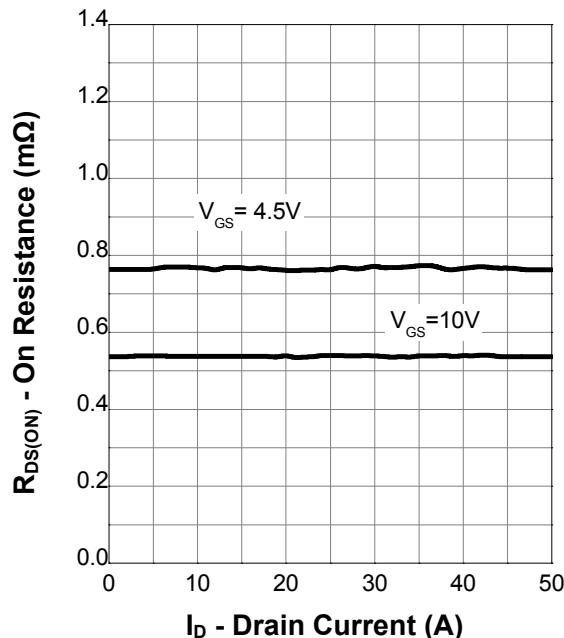


6. Typical Characteristics (Cont.)

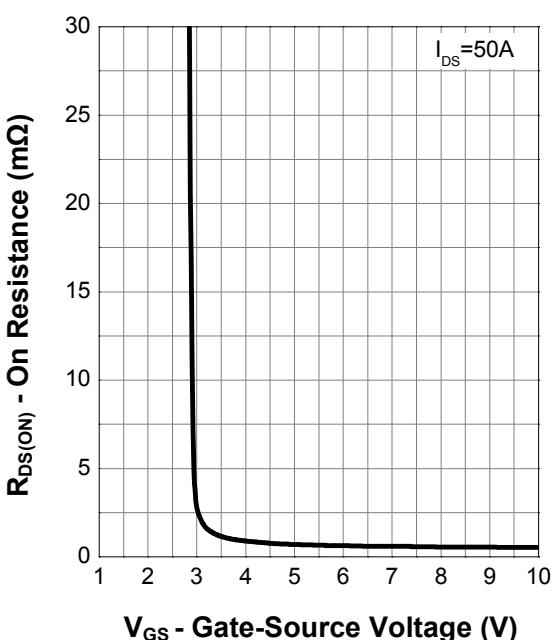
Output Characteristics



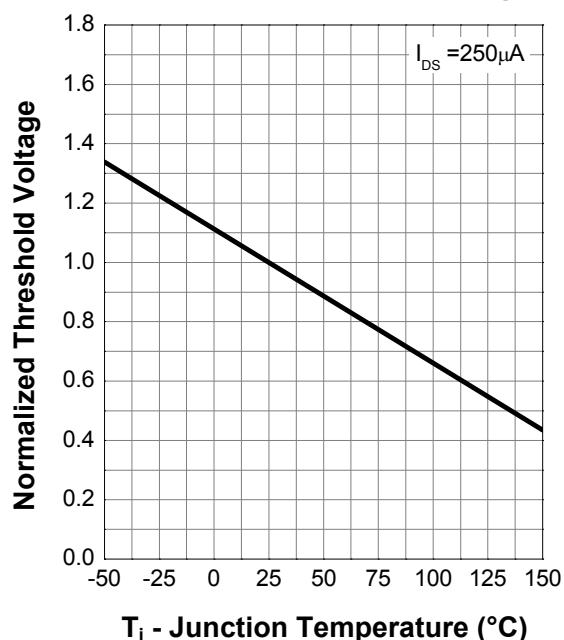
On Resistance



Transfer Characteristics

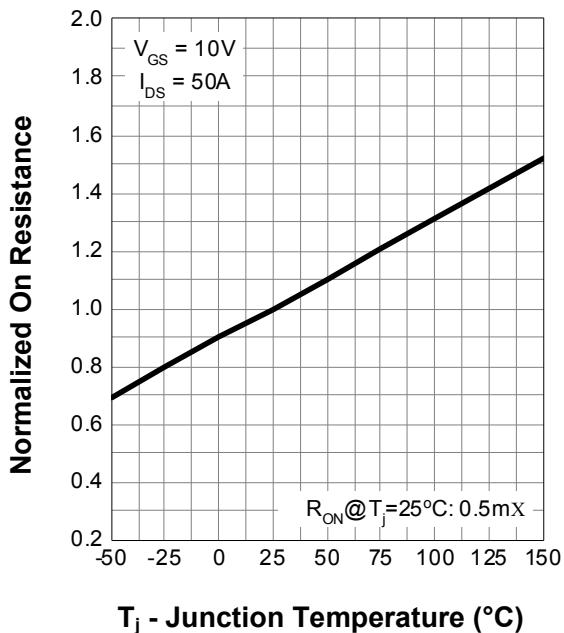


Normalized Threshold Voltage

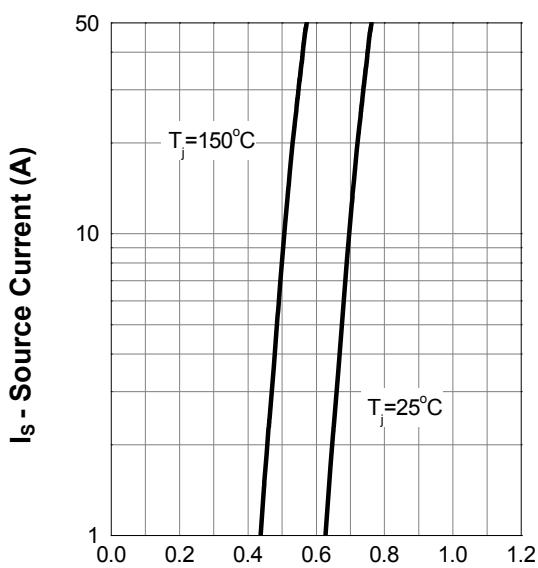


6. Typical Characteristics (Cont.)

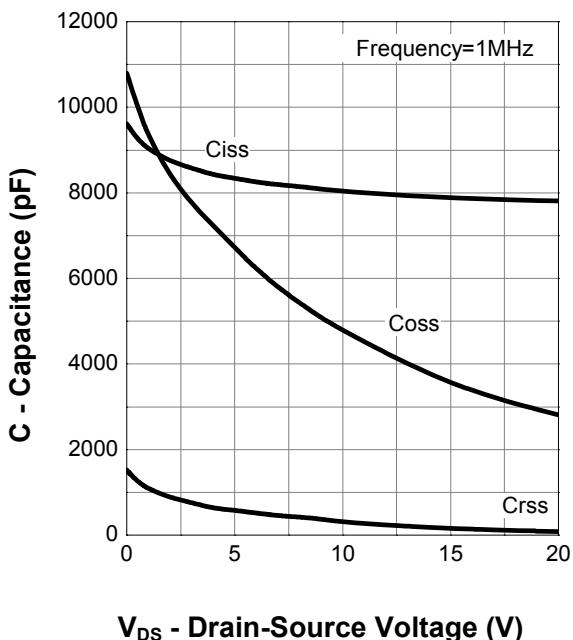
Normalized On Resistance



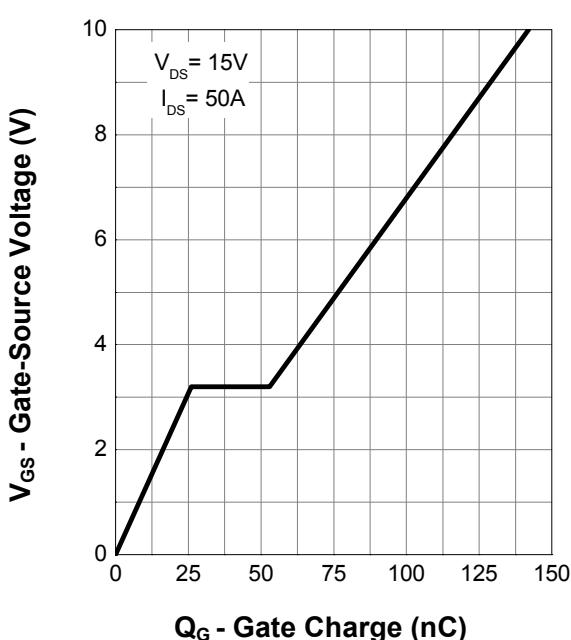
Diode Forward Current



Capacitance

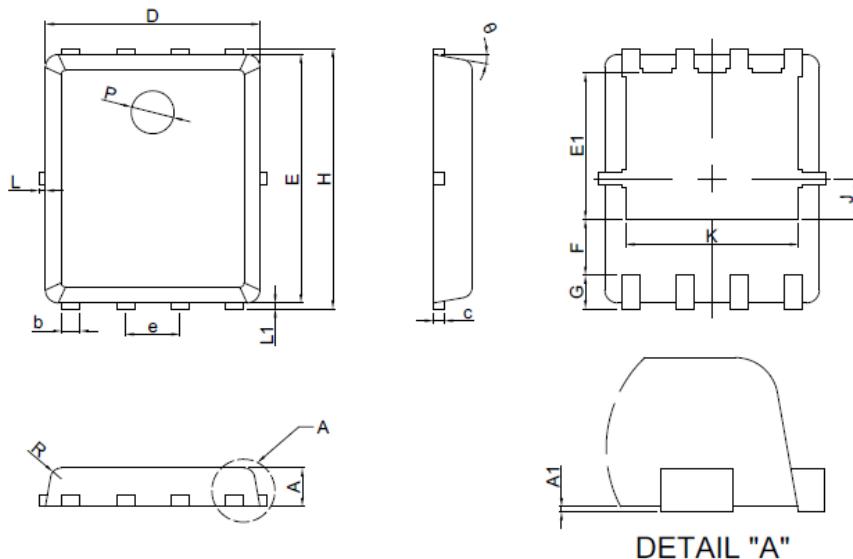


Gate Charge



7. Package Dimensions

PDFN-8 (5x6) Package



Symbol	Dimensions In Millimeters	
	MIN.	MAX.
A	0.80	1.00
A1	0.00	0.05
b	0.35	0.49
c	0.254REF	
D	4.90	5.10
F	1.40REF	
E	5.70	5.90
e	1.27BSC	
H	5.95	6.20
L1	0.10	0.18
G	0.60REF	
K	4.00REF	
L	-	0.15
J	0.95BSC	
P	1.00REF	
E1	3.40REF	
θ	6°	14°
R	0.25REF	

Note:

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